

# BLL6H1214L-250; BLL6H1214LS-250

LDMOS L-band radar power transistor

Rev. 4 — 1 September 2015

AMPLEON

Product data sheet

## 1. Product profile

### 1.1 General description

250 W LDMOS power transistor intended for L-band radar applications in the 1.2 GHz to 1.4 GHz range.

**Table 1. Test information**

Typical RF performance at  $T_{case} = 25\text{ }^{\circ}\text{C}$ ;  $t_p = 300\text{ }\mu\text{s}$ ;  $\delta = 10\text{ }\%$ ;  $I_{Dq} = 100\text{ mA}$ ; in a class-AB production test circuit.

Mode of operation	f (GHz)	V <sub>DS</sub> (V)	P <sub>L</sub> (W)	G <sub>p</sub> (dB)	$\eta_D$ (%)	t <sub>r</sub> (ns)	t <sub>f</sub> (ns)
pulsed RF	1.2 to 1.4	50	250	17	55	15	5

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### 1.2 Features and benefits

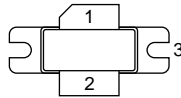
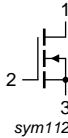
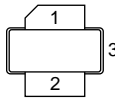
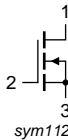
- Typical pulsed RF performance at a frequency of 1.2 GHz to 1.4 GHz, a supply voltage of 50 V, an  $I_{Dq}$  of 100 mA, a  $t_p$  of 300  $\mu\text{s}$  with  $\delta$  of 10 %:
  - ◆ Output power = 250 W
  - ◆ Power gain = 17 dB
  - ◆ Efficiency = 55 %
- Easy power control
- Integrated ESD protection
- High flexibility with respect to pulse formats
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (1.2 GHz to 1.4 GHz)
- Internally matched for ease of use
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

## 1.3 Applications

- L-band power amplifiers for radar applications in the 1.2 GHz to 1.4 GHz frequency range

## 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
<b>BLL6H1214L-250 (SOT502A)</b>			
1	drain		 sym112
2	gate		
3	source		
<b>BLL6H1214LS-250 (SOT502B)</b>			
1	drain		 sym112
2	gate		
3	source		

[1] Connected to flange.

## 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLL6H1214L-250	-	flanged LDMOST ceramic package; 2 mounting holes; 2 leads	SOT502A
BLL6H1214LS-250	-	earless flanged LDMOST ceramic package; 2 leads	SOT502B

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	100	V
$V_{GS}$	gate-source voltage		-0.5	+13	V
$I_D$	drain current		-	42	A
$T_{stg}$	storage temperature		-65	+150	°C
$T_j$	junction temperature		-	200	°C

## 5. Thermal characteristics

**Table 5. Thermal characteristics**

Symbol	Parameter	Conditions	Typ	Unit
$Z_{th(j-c)}$	transient thermal impedance from junction to case	$T_{case} = 85\text{ °C}; P_L = 250\text{ W}$		
		$t_p = 100\text{ }\mu\text{s}; \delta = 10\text{ }\%$	0.10	K/W
		$t_p = 200\text{ }\mu\text{s}; \delta = 10\text{ }\%$	0.13	K/W
		$t_p = 300\text{ }\mu\text{s}; \delta = 10\text{ }\%$	0.15	K/W
		$t_p = 100\text{ }\mu\text{s}; \delta = 20\text{ }\%$	0.14	K/W
		$t_p = 500\text{ }\mu\text{s}; \delta = 20\text{ }\%$	0.20	K/W

## 6. Characteristics

**Table 6. DC characteristics**

$T_j = 25\text{ °C}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0\text{ V}; I_D = 2.7\text{ mA}$	100	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$V_{DS} = 10\text{ V}; I_D = 270\text{ mA}$	1.3	1.8	2.25	V
$I_{DSS}$	drain leakage current	$V_{GS} = 0\text{ V}; V_{DS} = 50\text{ V}$	-	-	1.4	$\mu\text{A}$
$I_{DSX}$	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75\text{ V}; V_{DS} = 10\text{ V}$	32	42	-	A
$I_{GSS}$	gate leakage current	$V_{GS} = 11\text{ V}; V_{DS} = 0\text{ V}$	-	-	140	nA
$g_{fs}$	forward transconductance	$V_{DS} = 10\text{ V}; I_D = 270\text{ mA}$	1.6	2.3	-	S
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75\text{ V}; I_D = 9.5\text{ A}$	-	100	169	m $\Omega$

**Table 7. RF characteristics**

Mode of operation: pulsed RF;  $t_p = 300\text{ }\mu\text{s}; \delta = 10\text{ }\%$ ; RF performance at  $V_{DS} = 50\text{ V}; I_{Dq} = 100\text{ mA}; T_{case} = 25\text{ °C}$ ; unless otherwise specified, in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$P_L$	output power		250	-	-	W
$V_{DS}$	drain-source voltage	$P_L = 250\text{ W}$	-	-	50	V
$G_p$	power gain	$P_L = 250\text{ W}$	15	17	-	dB
$t_p$	pulse duration	$P_L = 250\text{ W}$	-	300	500	$\mu\text{s}$
$\delta$	duty cycle	$P_L = 250\text{ W}$	-	10	20	%
$RL_{in}$	input return loss	$P_L = 250\text{ W}$	-	10	-	dB
$P_{L(1dB)}$	output power at 1 dB gain compression		-	300	-	W
$\eta_D$	drain efficiency	$P_L = 250\text{ W}$	49	55	-	%
$P_{droop(pulse)}$	pulse droop power	$P_L = 250\text{ W}$	-	0	0.3	dB
$t_r$	rise time	$P_L = 250\text{ W}$	-	15	-	ns
$t_f$	fall time	$P_L = 250\text{ W}$	-	5	-	ns

## 6.1 Ruggedness in class-AB operation

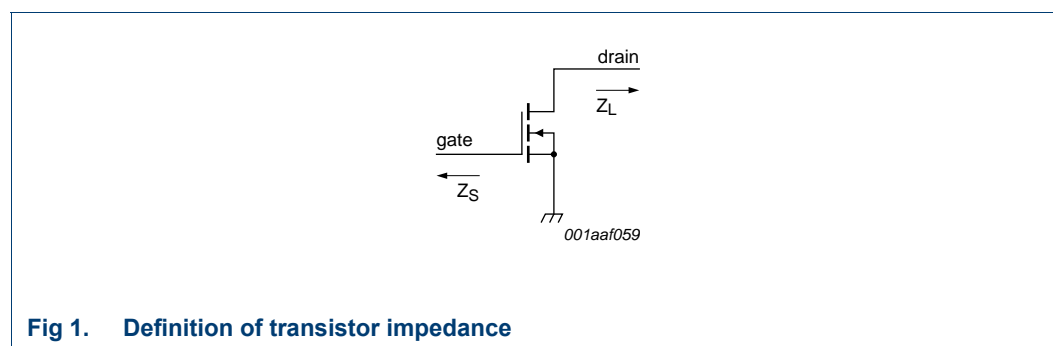
The BLL6H1214L-250 and BLL6H1214LS-250 are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS} = 50$  V;  $I_{DQ} = 100$  mA;  $P_L = 250$  W;  $t_p = 300$   $\mu$ s;  $\delta = 10$  %.

## 7. Application information

### 7.1 Impedance information

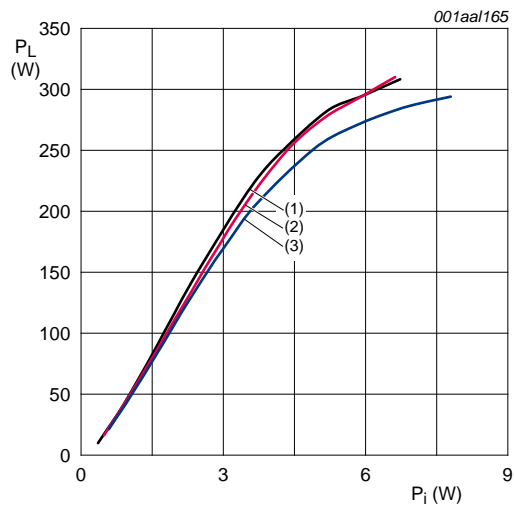
**Table 8. Typical impedance**  
Typical values unless otherwise specified.

<b>f</b> <b>GHz</b>	<b><math>Z_S</math></b> <b><math>\Omega</math></b>	<b><math>Z_L</math></b> <b><math>\Omega</math></b>
1.2	1.268 – j2.623	2.987 – j1.664
1.3	2.193 – j2.457	2.162 – j1.326
1.4	2.359 – j2.052	1.604 – j1.887



**Fig 1. Definition of transistor impedance**

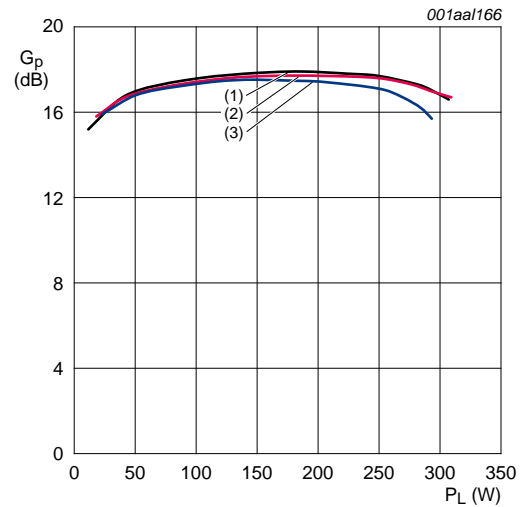
## 7.2 RF performance



$V_{DS} = 50 \text{ V}$ ;  $t_p = 300 \text{ } \mu\text{s}$ ;  $\delta = 10 \%$ ;  $I_{Dq} = 100 \text{ mA}$ .

- (1)  $f = 1200 \text{ MHz}$
- (2)  $f = 1300 \text{ MHz}$
- (3)  $f = 1400 \text{ MHz}$

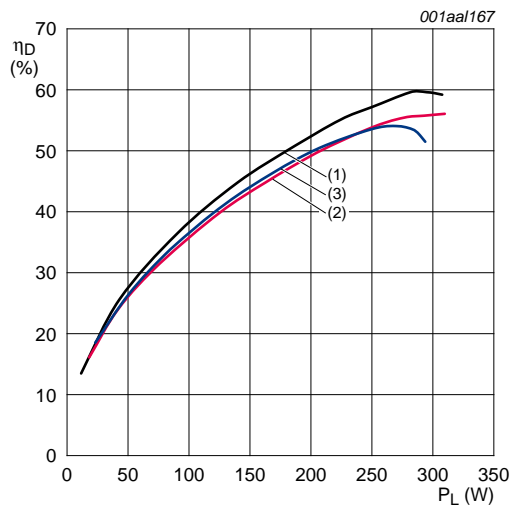
**Fig 2. Output power as a function of input power; typical values**



$V_{DS} = 50 \text{ V}$ ;  $t_p = 300 \text{ } \mu\text{s}$ ;  $\delta = 10 \%$ ;  $I_{Dq} = 100 \text{ mA}$ .

- (1)  $f = 1200 \text{ MHz}$
- (2)  $f = 1300 \text{ MHz}$
- (3)  $f = 1400 \text{ MHz}$

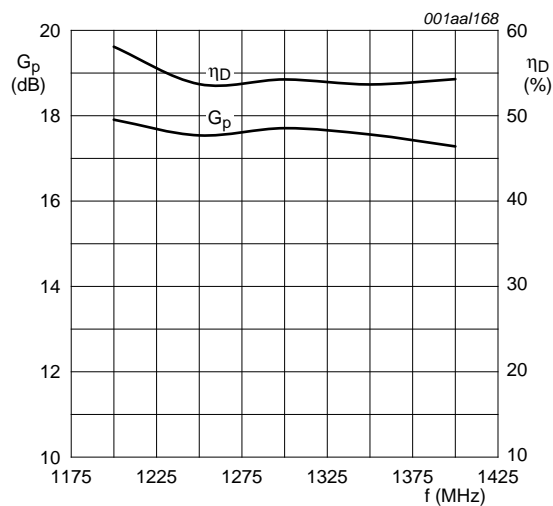
**Fig 3. Power gain as a function of load power; typical values**



$V_{DS} = 50 \text{ V}$ ;  $t_p = 300 \text{ } \mu\text{s}$ ;  $\delta = 10 \text{ } \%$ ;  $I_{Dq} = 100 \text{ mA}$ .

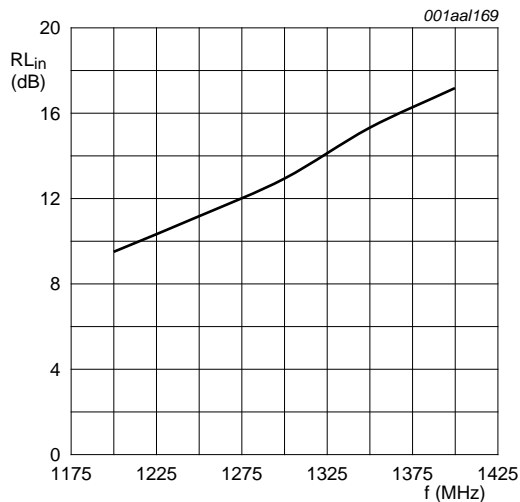
- (1)  $f = 1200 \text{ MHz}$
- (2)  $f = 1300 \text{ MHz}$
- (3)  $f = 1400 \text{ MHz}$

**Fig 4. Drain efficiency as a function of load power; typical values**



$P_L = 250 \text{ W}$ ;  $V_{DS} = 50 \text{ V}$ ;  $t_p = 300 \text{ } \mu\text{s}$ ;  $\delta = 10 \text{ } \%$ ;  $I_{Dq} = 100 \text{ mA}$ .

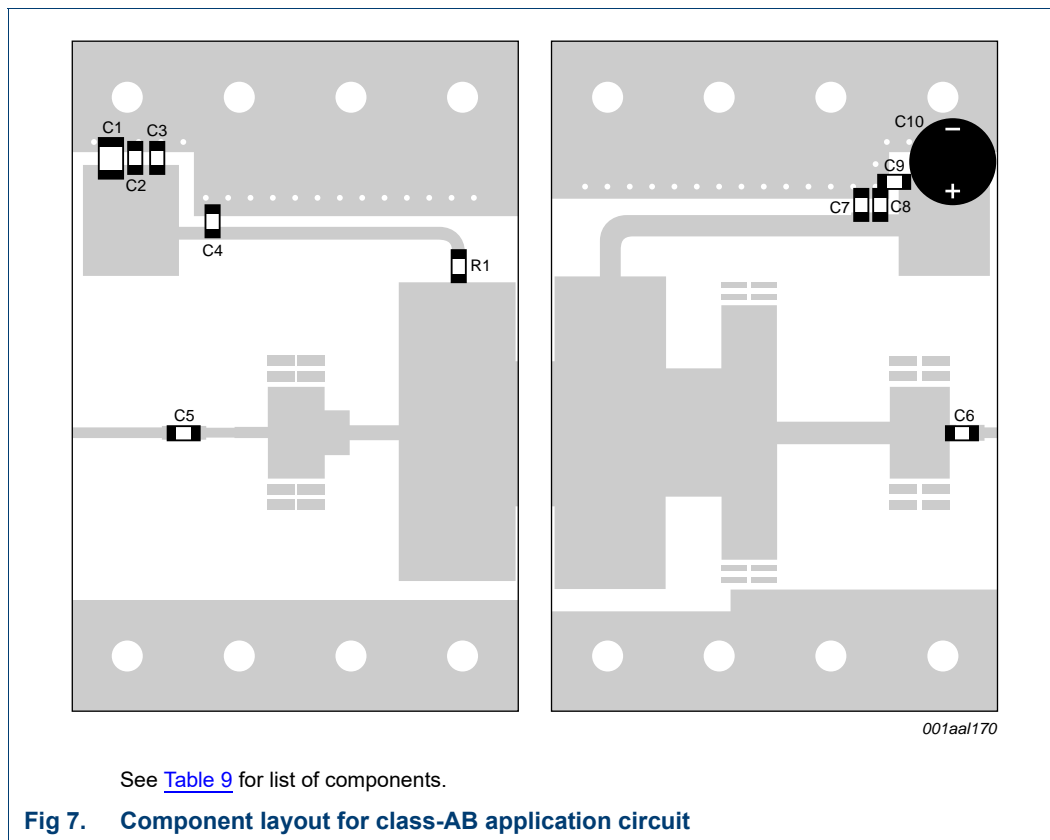
**Fig 5. Power gain and drain efficiency as function of frequency; typical values**



$P_L = 250 \text{ W}$ ;  $V_{DS} = 50 \text{ V}$ ;  $t_p = 300 \text{ } \mu\text{s}$ ;  $\delta = 10 \text{ } \%$ ;  $I_{Dq} = 100 \text{ mA}$ .

**Fig 6. Input return loss as a function of frequency; typical value**

### 7.3 Application circuit



**Table 9. List of components**

See [Figure 7](#).

Striplines are on a Rogers Duroid 6006 Printed-Circuit Board (PCB);  $\epsilon_r = 6.15$  F/m; thickness = 0.64 mm

Component	Description	Value	Remarks
C1	multilayer ceramic chip capacitor	10 $\mu$ F; 35 V	[1]
C2, C4	multilayer ceramic chip capacitor	51 pF	[2]
C3, C8	multilayer ceramic chip capacitor	1 nF	[2]
C5	multilayer ceramic chip capacitor	82 pF	[3]
C6, C7	multilayer ceramic chip capacitor	56 pF	[3]
C9	multilayer ceramic chip capacitor	100 pF	[3]
C10	electrolytic capacitor	47 $\mu$ F; 63 V	
R1	SMD resistor	10 $\Omega$	0603

[1] American Technical Ceramics type 100A or capacitor of same quality.

[2] American Technical Ceramics type 100B or capacitor of same quality.

[3] American Technical Ceramics type 800B or capacitor of same quality.

8. Package outline

Flanged ceramic package; 2 mounting holes; 2 leads

SOT502A

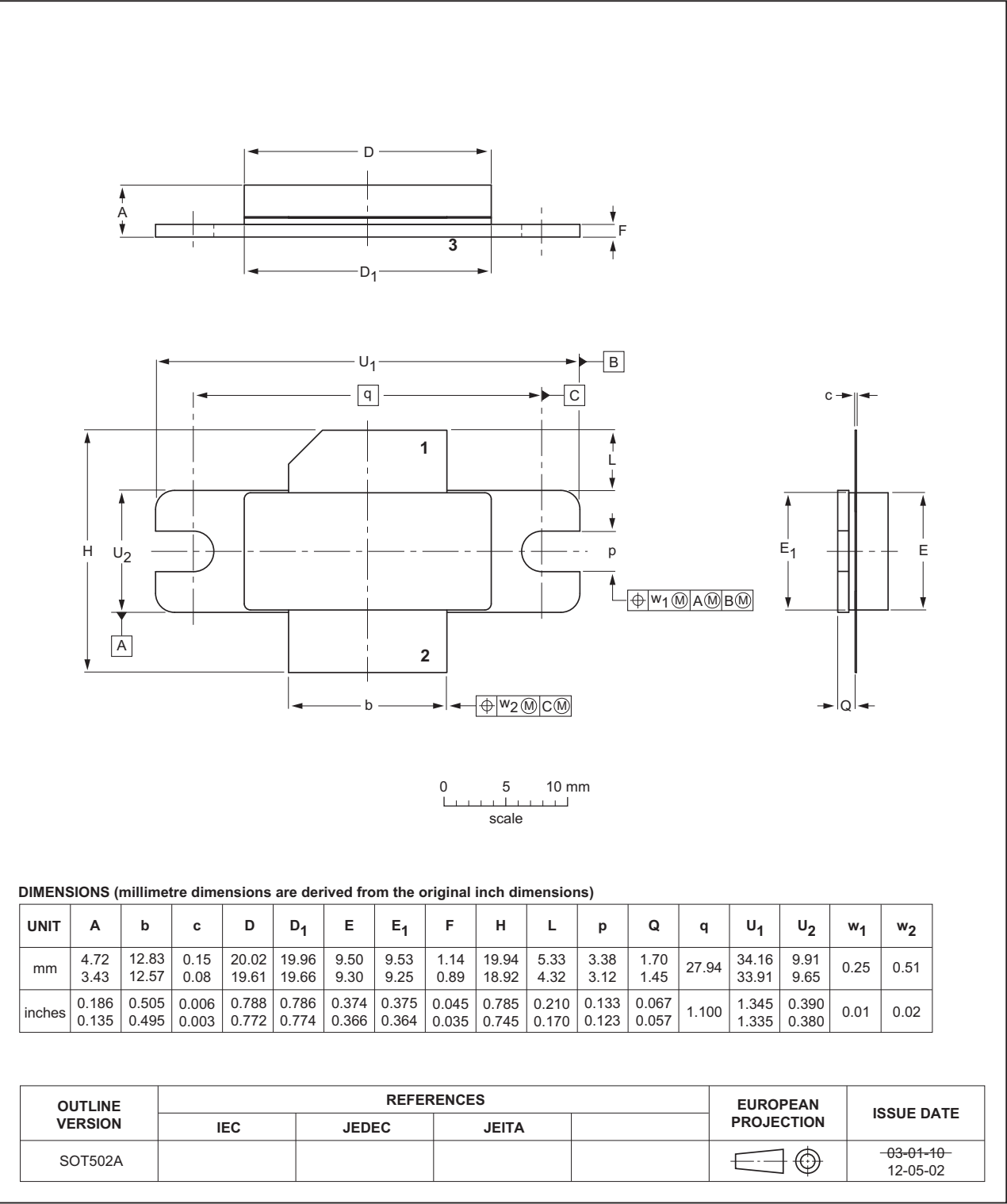
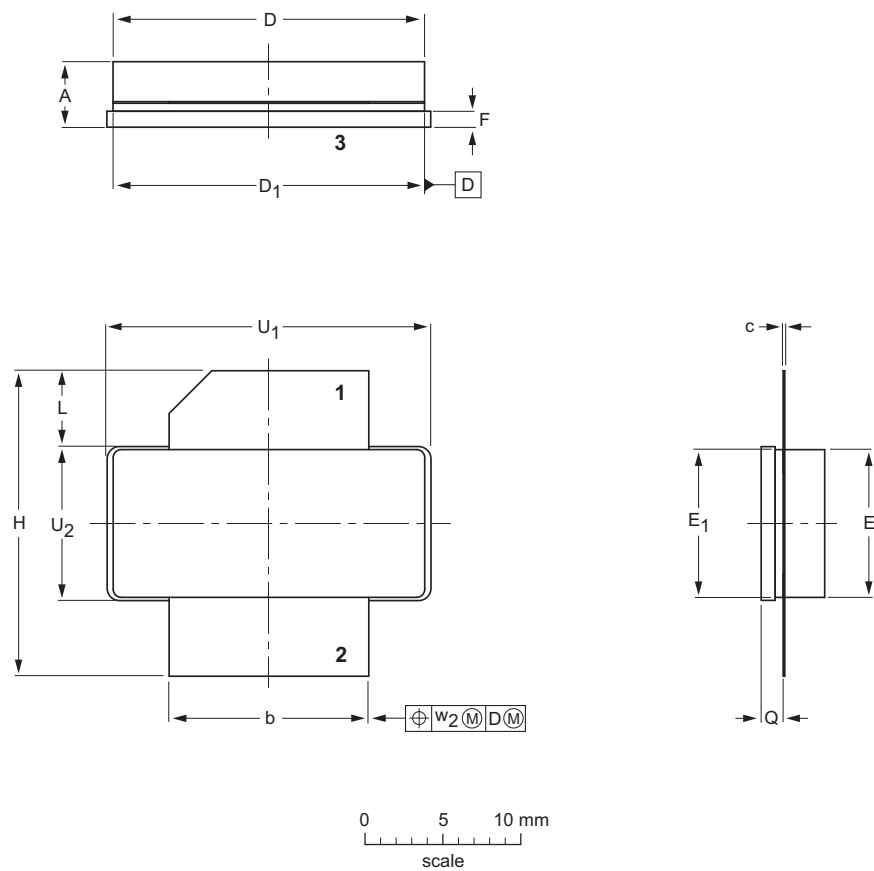


Fig 8. Package outline SOT502A



Earless flanged ceramic package; 2 leads

SOT502B



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	D <sub>1</sub>	E	E <sub>1</sub>	F	H	L	Q	U <sub>1</sub>	U <sub>2</sub>	w <sub>2</sub>
mm	4.72 3.43	12.83 12.57	0.15 0.08	20.02 19.61	19.96 19.66	9.50 9.30	9.53 9.25	1.14 0.89	19.94 18.92	5.33 4.32	1.70 1.45	20.70 20.45	9.91 9.65	0.25
inches	0.186 0.135	0.505 0.495	0.006 0.003	0.788 0.772	0.786 0.774	0.374 0.366	0.375 0.364	0.045 0.035	0.785 0.745	0.210 0.170	0.067 0.057	0.815 0.805	0.390 0.380	0.010

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT502B						07-05-09 12-05-02

Fig 9. Package outline SOT502B

## 9. Abbreviations

**Table 10. Abbreviations**

Acronym	Description
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor
RF	Radio Frequency
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio

## 10. Revision history

**Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLL6H1214L-250_1214LS-250#4	20150901	Product data sheet		BLL6H1214L-250_1214LS-250#3
Modifications:	<ul style="list-style-type: none"> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>			
BLL6H1214L-250_1214LS-250#3	20100714	Product data sheet	-	BLL6H1214L-250_1214LS-250#2
BLL6H1214L-250_1214LS-250#2	20100302	Objective data sheet	-	BLL6H1214L-250_1214LS-250#1
BLL6H1214L-250_1214LS-250#1	20091211	Objective data sheet	-	-

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### 11.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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